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CONFIRMATION NO. 5611

<b>SERIAL NUMBER</b> 10/690,782	<b>FILING OR 371(c) DATE</b> 10/21/2003 <b>RULE</b>	<b>CLASS</b> 257	<b>GROUP ART UNIT</b> 2822	<b>ATTORNEY DOCKET NO.</b> 9903-071
<b>APPLICANTS</b> Jin-Hyuk Lee, Kyungki-Do, KOREA, REPUBLIC OF; Gu-Sung Kim, Kyungki-do, KOREA, REPUBLIC OF; Dong-Ho Lee, Kyungki-do, KOREA, REPUBLIC OF; Dong-Hyeon Jang, Seoul, KOREA, REPUBLIC OF;				
<b>** CONTINUING DATA *****</b> <i>NONE</i>				
<b>** FOREIGN APPLICATIONS *****</b> REPUBLIC OF KOREA 2002-64513 10/22/2002				
<b>IF REQUIRED, FOREIGN FILING LICENSE GRANTED **</b> 01/20/2004				
Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance Verified and Acknowledged	Examiner's Signature <i>[Signature]</i> Initials <i>[Initials]</i>	<b>STATE OR COUNTRY</b> KOREA, REPUBLIC OF	<b>SHEETS DRAWING</b> 10	<b>TOTAL CLAIMS</b> 17
<b>INDEPENDENT CLAIMS</b> 3				
<b>ADDRESS</b> 20575				
<b>TITLE</b> Method for manufacturing a wafer level chip scale package				
<b>FILING FEE RECEIVED</b> 970	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit	